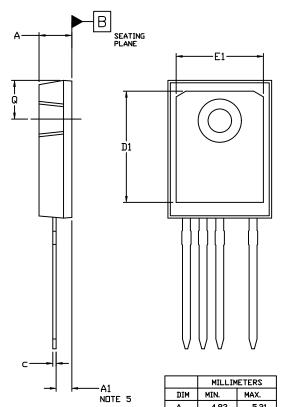


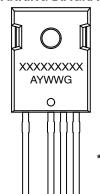
DATE 07 MAY 2020



NUTES

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETER
- 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.13 PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE DUTERMOST EXTREME OF THE PLASTIC BODY.
- 4. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.
- 5. DIMENSION AT TO BE MEASURED IN THE REGION DEFINED BY L1.
- NOTCHES ARE REQUIRED BUT THEIR SHAPE IS OPTIONAL.
- 7. DIAMETER P SHALL HAVE A MAXIMUM DRAFT ANGLE OF 3.5° TO THE TOP OF THE PART WITH A MAXIMUM DIAMETER OF 4.20.

GENERIC MARKING DIAGRAM*



A	4.83 5.21		
A1	2.29 2.54		
b	1.10 1.30		
b2	1.30	1.50	
С	0.50	0.70	
D	20.80	21.10	
D1	16.25	17.65	
Ε	15.75	16.13	
E1	13.06	13.46	
E2	4.32	4.83	
е	2.54 BSC		
٦	19.90	20.30	
L1	4.00	4.00 4.40	
Р	3.50	3.50 3.70	
Q	5.59	6.20	
S	6.15 BSC		

XXXXX = Specific Device Code = Assembly Location Α = Year

WW = Work Week G = Pb-Free Package *This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

DOCUMENT NUMBER:	98AON97044F	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.	
DESCRIPTION:	TO-247 4-LEAD		PAGE 1 OF 1

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.